

MODEL NO. : TM028HDH02ISSUED DATE: 2009-04-23VERSION : Ver 2.1

- ☐ Preliminary Specification
☒ Final Product Specification

Customer : _____

Approved by	Notes

SHANGHAI TIANMA Confirmed :

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This technical specification is subjected to change without notice

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Table of Contents

Coversheet.....	1
Table of Contents	2
Record of Revision.....	3
1 General Specifications	4
2 Input/Output Terminals	5
3 Absolute Maximum Ratings	7
4 Electrical Characteristics.....	8
5 Timing Chart.....	10
6 Optical Characteristics	16
7 Environmental / Reliability tests	20
8 Mechanical Drawing	21
9 Packing Drawing	22
10 Precautions for Use of LCD Modules	24

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1 General Specifications

Feature		Spec
Display Spec.	Size	2.83 inch
	Resolution	240(RGB) X 320
	Interface	CPU
	Color Depth	262K
	Technology Type	a-Si TFT
	Pixel Pitch (mm)	0.180x0.180
	Pixel Configuration	R.G.B. Vertical Stripe
	Display Mode	TM with Normally White
	Surface Treatment(Up Polarizer)	Clear Type (3H)
	Viewing Direction	6 o'clock
	Gray Scale Inversion Direction	12 o'clock
Mechanical Characteristics	LCM (W x H x D) (mm)	50.0x70.0x2.15
	Active Area(mm)	43.2 x 57.6
	With /Without TSP	Without TSP
	Weight (gram)	15.28
	LED Numbers	5 LEDs
Electronic	Driver IC	ILI9325

Note 1 : Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift.

Note 2 : Requirements on Environmental Protection: RoHS

Note 3: LCD weight tolerance: $\pm 0.5\%$



2 Input/Output Terminals

2.1 TFT LCD Panel

No	Symbol	I/O	Description				Remarks
1	GND	P	Ground				
2	GND	P	Ground				
3	ID (IOVCC)	-	Identify pin or IOVCC				
4	IM0	I	IM3	IM0	Interface mode	DB Pin	
5	IM3	I	0	1	80-system interface	8-bit DB17-10	
			0	0	80-system interface	16-bit DB17-10 DB8-DB1	
			1	1	80-system interface	9-bit DB17-DB9	
			1	0	80-system interface	18-bit DB17-DB0	
6	RESET	I	A RESET signal				
7	DB17	I	Data input				
8	DB16	I	Data input				
9	DB15	I	Data input				
10	DB14	I	Data input				
11	DB13	I	Data input				
12	DB12	I	Data input				
13	DB11	I	Data input				
14	DB10	I	Data input				
15	DB9	I	Data input				
16	DB8	I	Data input				
17	DB7	I	Data input				
18	DB6	I	Data input				
19	DB5	I	Data input				
20	DB4	I	Data input				
21	DB3	I	Data input				
22	DB2	I	Data input				
23	DB1	I	Data input				
24	DB0	I	Data input				
25	RD	I	A read strobe signal and activates when the signal is low				
26	WR	I	A write strobe signal and activates when the signal is low				
27	RS	I	A register select signal				
28	CS	I	A chip select signal				
29	IOVCC	P	Power Supply of Digital Circuit				
30	IOVCC	P	Power Supply of Digital Circuit				
31	VCC	P	Power Supply of Analog Circuit				
32	VCC	P	Power Supply of Analog Circuit				
33	NC	-	Not Connect				
34	AN	I	LED anode				
35	CA	I	LED cathode				Note 2-2

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36	VSYNC	I	Frame synchronous signal	
37	FMARK	I	Frame head pulse signal	
38	NC	-	Not Connect	
39	GND	P	Ground	

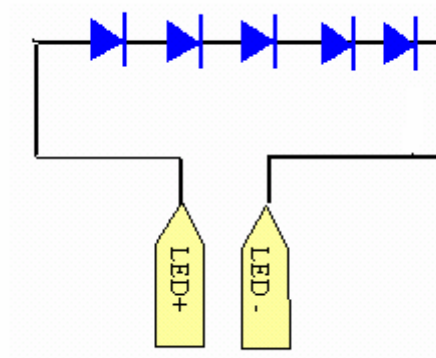
Note2-1: I/O definition:

I-----Input

O---Output

P----Power

Note 2-2: The figure below shows the connection of backlight LED.





3 Absolute Maximum Ratings

3.1 Driving TFT LCD Panel

 $T_a = 25^{\circ}\text{C}$

Item	Symbol	MIN	MAX	Unit	Remark
Logic Supply Voltage	IOVCC	-0.3	4.6	V	
Analog Supply Voltage	VCC	-0.3	4.6	V	
Input Signal Voltage		-0.3	VCC +0.3	V	
Touch Panel Pin Voltage	V_{TP}	--	7	V	
Back Light Forward Current	I_{LED}	--	25	mA	For each LED
Operating Temperature	T_{OPR}	-20	70	$^{\circ}\text{C}$	
Storage Temperature	T_{STG}	-30	80	$^{\circ}\text{C}$	



4 Electrical Characteristics

4.1 Driving TFT LCD Panel

GND=0V, Ta=25°C

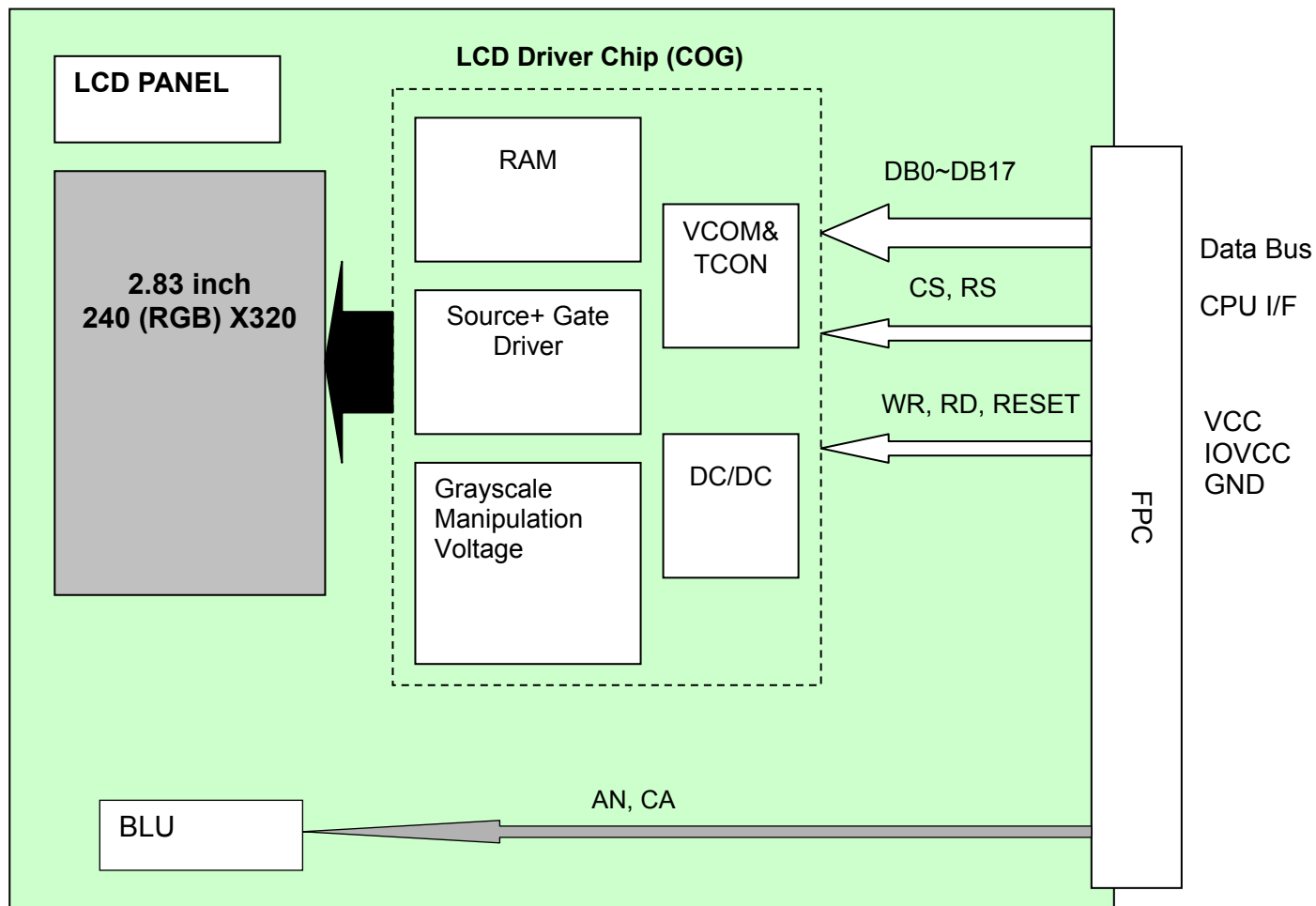
Item		Symbol	MIN	TYP	MAX	Unit	Remark
Logic Supply Voltage		IOVCC	1.65	1.8	3.3	V	
Analog Supply Voltage		VCC	2.5	2.8	3.3	V	
Input Signal Voltage	Low Level	V _{IL}	-0.3	--	0.2xVCC	V	
	High Level	V _{IH}	0.8xVCC	--	VCC	V	
Output Signal Voltage	Low Level	V _{OL}	--	--	0.2xVCC	V	
	High Level	V _{OH}	0.8xVCC	--	--	V	
(Panel+ LSI) Power Consumption		Black Mode (60Hz)	--	20	25	mW	
		Standby Mode	--	100	--	μ W	
		Sleeping Mode	--	200	--	μ W	

4.2 Driving Backlight Ta=25°C

Item	Symbol	MIN	TYP	MAX	Unit	Remark
Forward Current	I _F	--	20	--	mA	
Forward Voltage	V _F	--	16	--	V	
Power Consumption	W _{BL}	--	320	--	mW	5 LEDs



4.3 Block Diagram





5 Timing Chart

5.1 Timing Parameter

Item		Symbol	Unit	Min	Typ	Max
Bus cycle time	Write	t_{CYCW}	ns	100	-	-
	Read	t_{CYCR}	ns	300	-	-
Write low-level pulse width		PW_{LW}	ns	50	-	500
Write high-level pulse width		PW_{HW}	ns	50	-	-
Read low-level pulse width		PW_{LR}	ns	150	-	-
Read high-level pulse width		PW_{HR}	ns	150	-	-
Write / Read rise / fall time		t_{WRr} / t_{WRf}	ns	-	-	25
Setup time	Write (RS to /CS, /WR)	t_{AS}	ns	10	-	-
	Read (RS to /CS, /RD)			5	-	-
Address hold time		t_{AH}	ns	5	-	-
Write data set up time		t_{DSW}	ns	10	-	-
Write data hold time		t_H	ns	15	-	-
Read data delay time		t_{DDR}	ns	-	-	100
Read data hold time		t_{DHR}	ns	5	-	-

Table 5.1 timing parameter

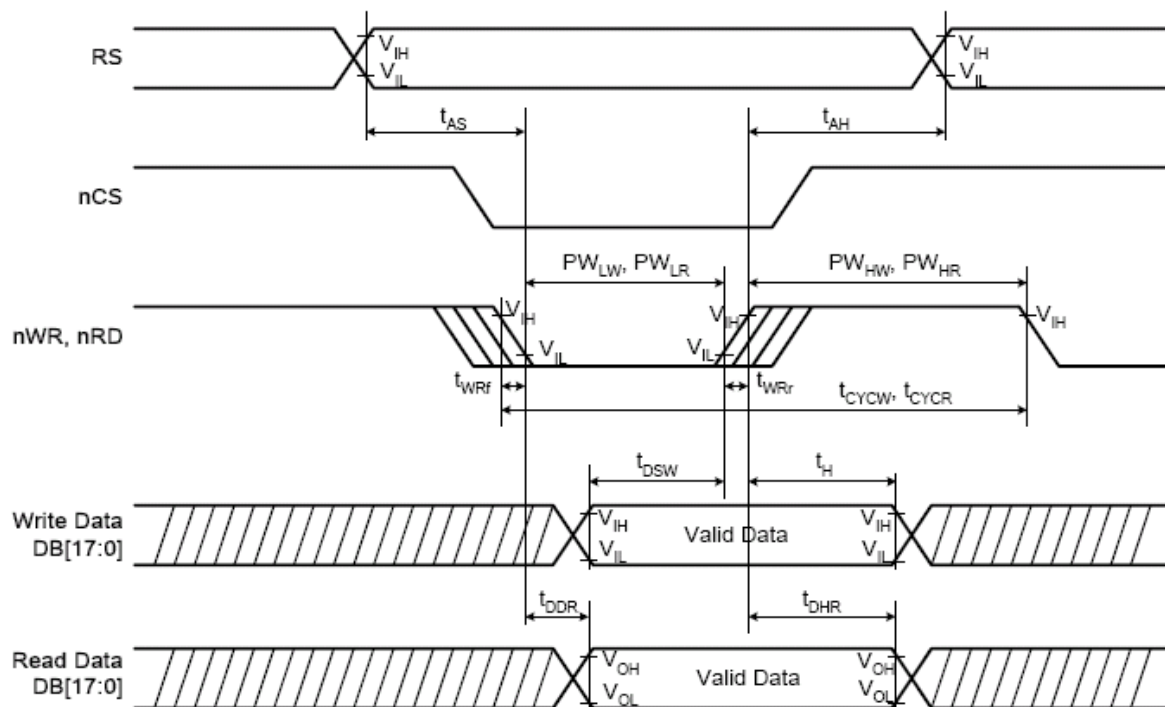


Figure 5.1 i80 System Bus Timing

5.2 Register write/read timing in I80 series system

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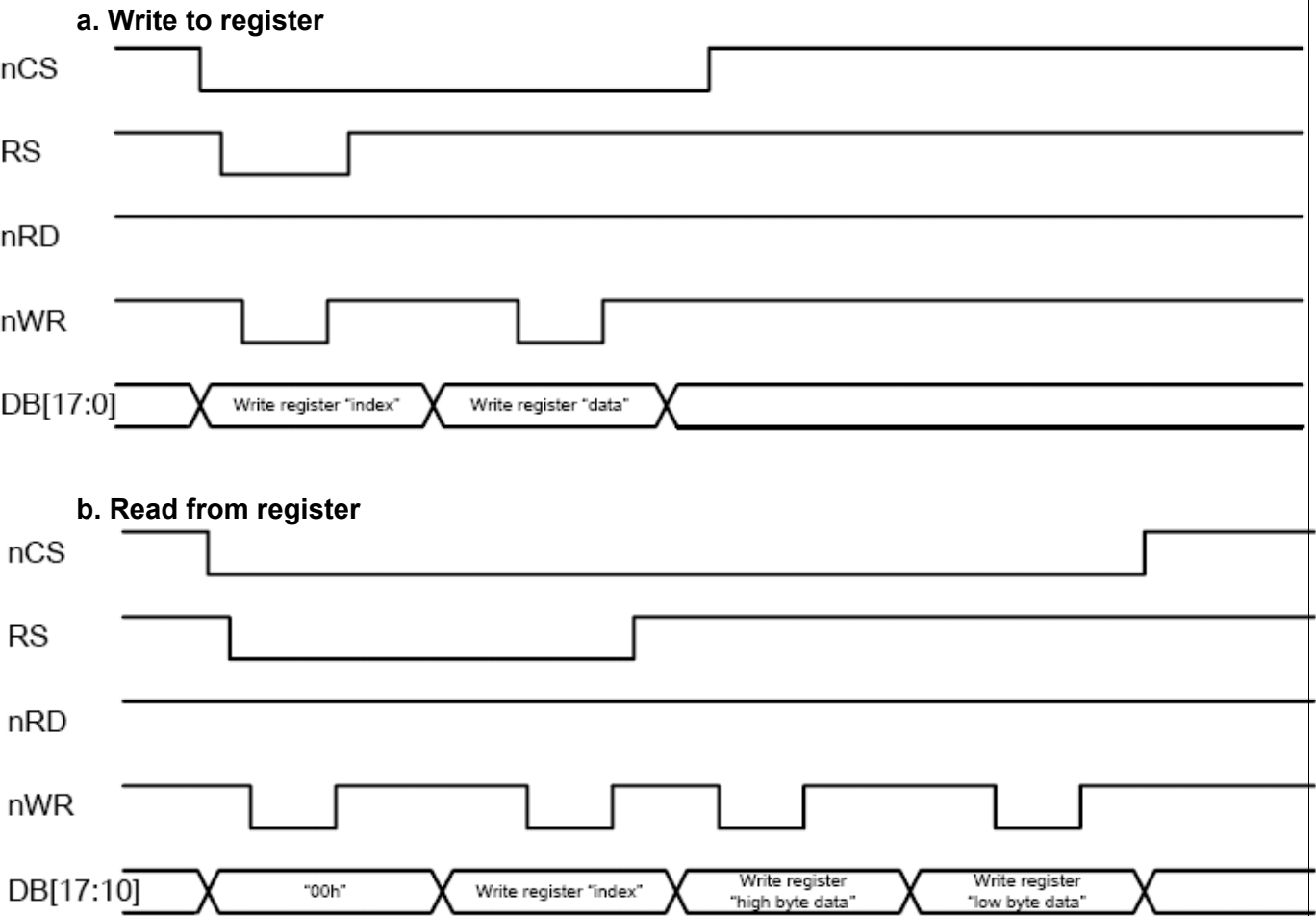


Figure 5.2 i80 18-bit System Bus Interface Timing



5.3 GRAM write/read timing in I80 series system

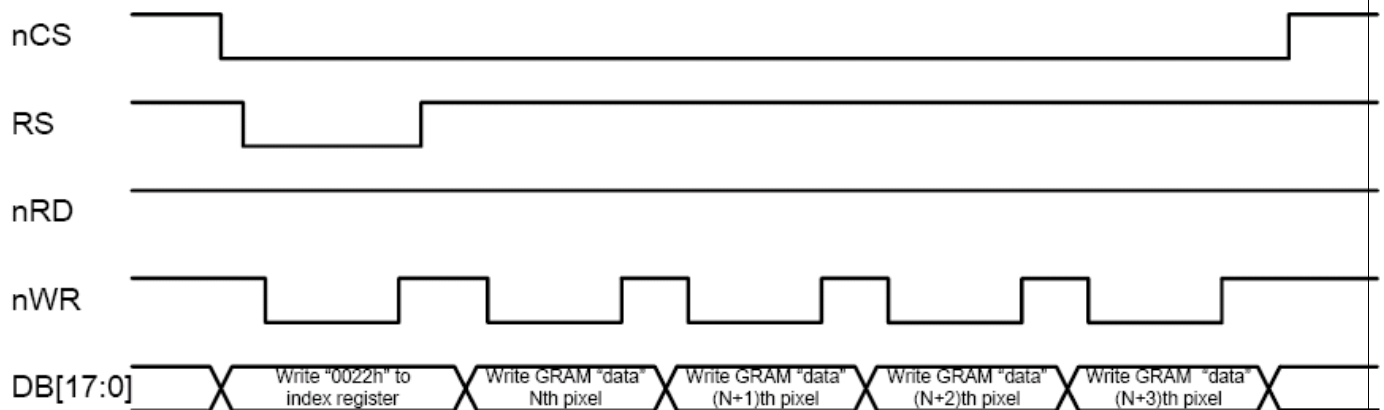
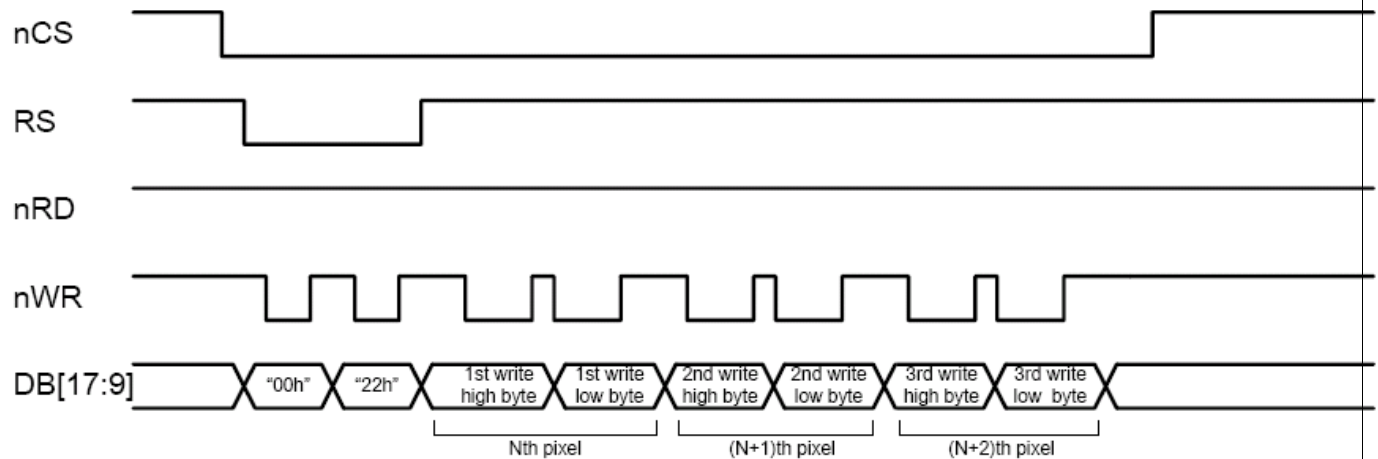
TRI	DFM	16-bit MPU System Interface Data Format
0	*	<p>system 16-bit interface (1 transfers/pixel) 65,536 colors</p>
1	0	<p>80-system 16-bit interface (2 transfers/pixel) 262,144 colors</p>
1	1	<p>80-system 16-bit interface (2 transfers/pixel) 262,144 colors</p>

Table 5.3.1 GRAM Data and display data of 16- bit system interface

TRI	DFM	8-bit MPU System Interface Data Format
0	*	<p>system 8-bit interface (2 transfers/pixel) 65,536 colors</p>
1	0	<p>80-system 8-bit interface (3 transfers/pixel) 262,144 colors</p>
1	1	<p>80-system 8-bit interface (3 transfers/pixel) 262,144 colors</p>

Table 5.3.2 GRAM Data and display data of 8- bit system interface

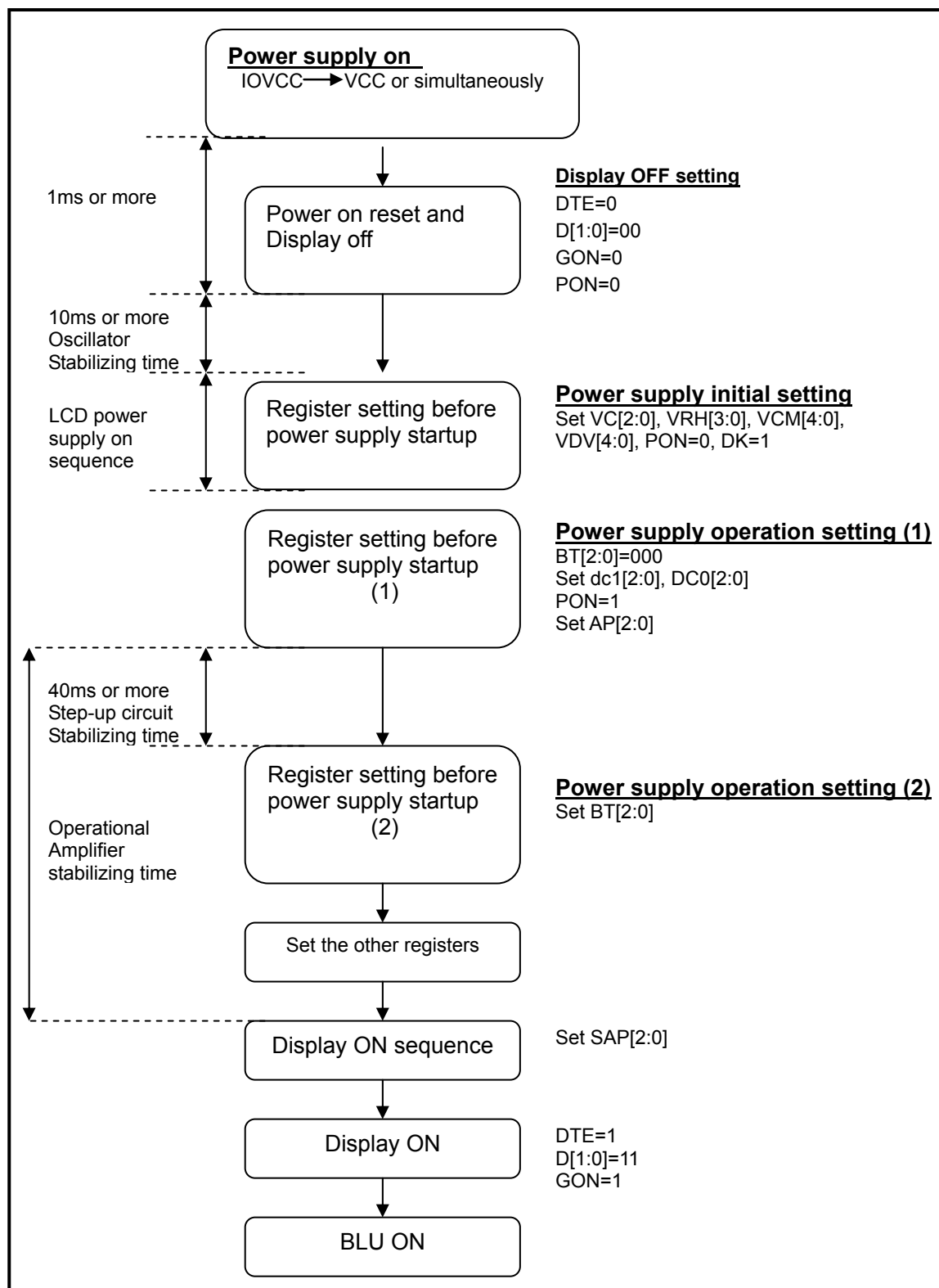
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**GRAM Write Timing****Figure 5.3.3 GRAM Read/Write Timing of i80 18/16-bit System Interface****Figure 5.3.4 GRAM Read/Write Timing of i80 9/8-bit System Interface**



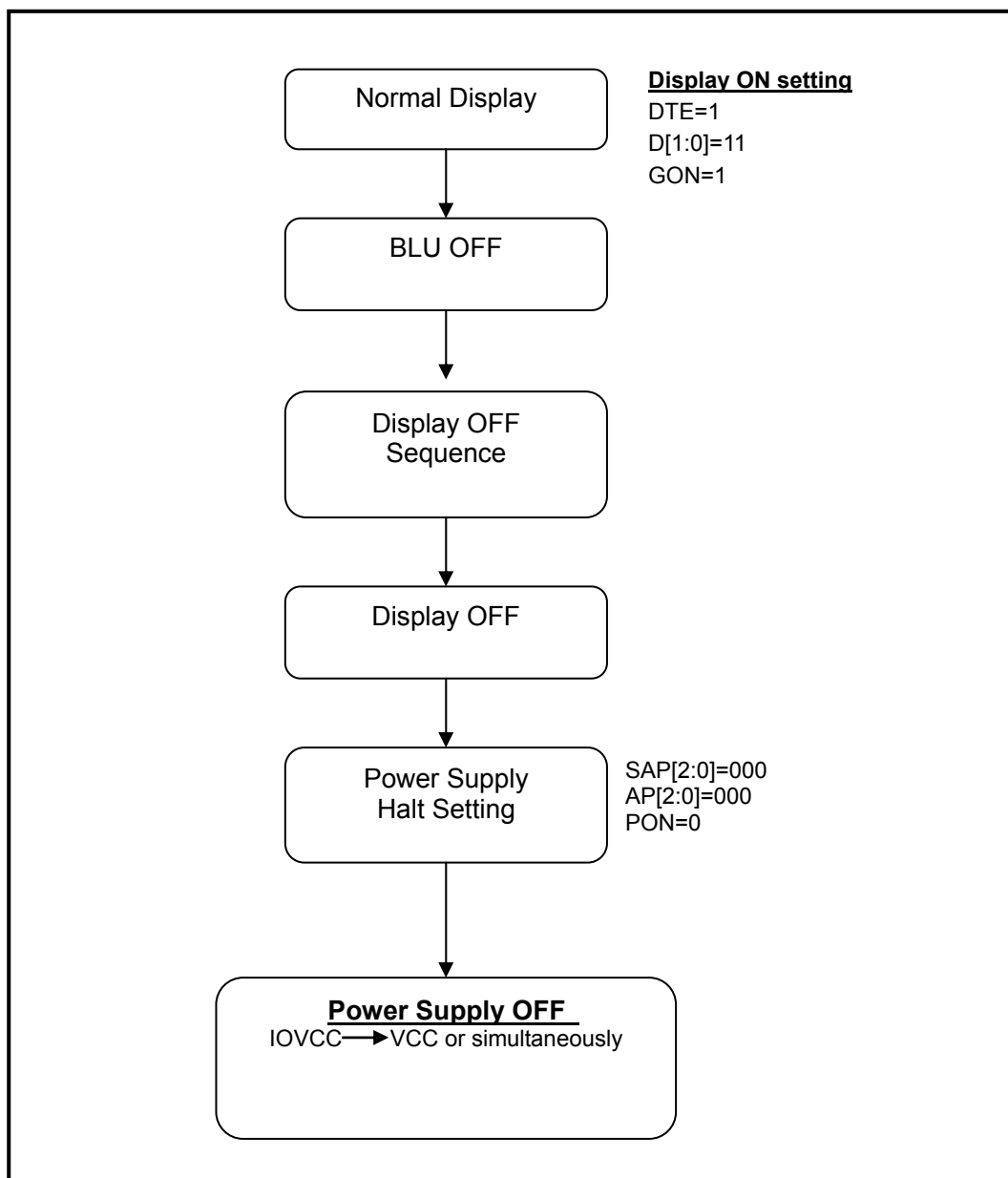
5.4 Power On/Off sequence

5.4.1 Power on Sequence





5.4.2 Power off Sequence





6 Optical Characteristics

6.1 Optical Specification

Ta=25°C

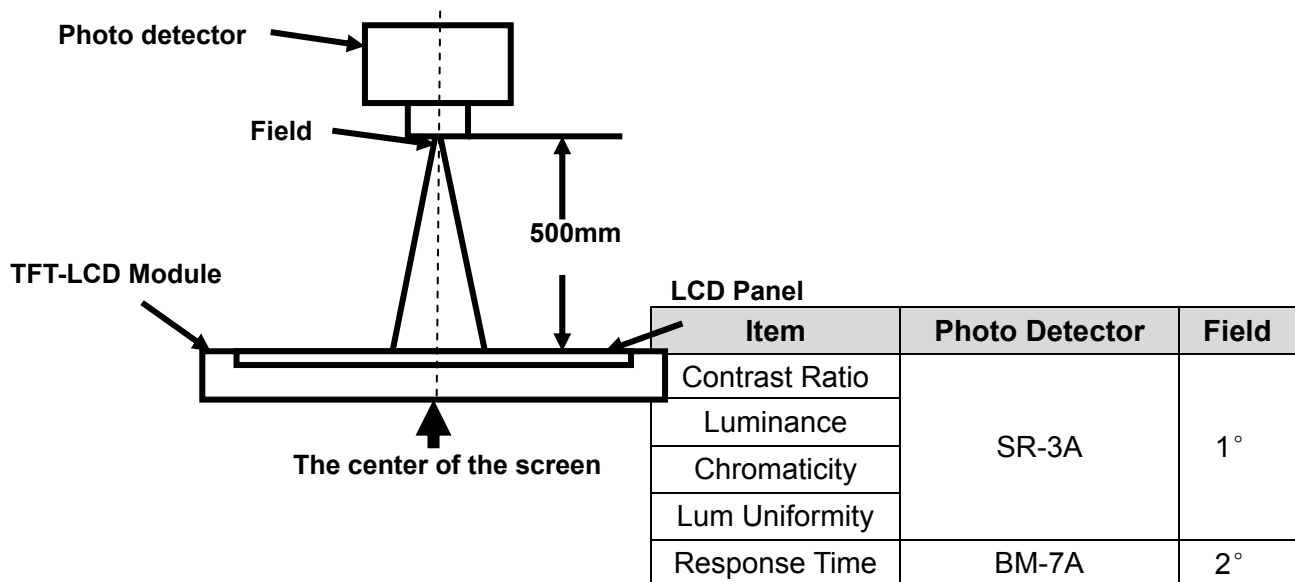
Item		Symbol	Condition	Min	Typ.	Max.	Unit	Remark
View Angles		θT	CR≥10	55	60	-	Degree	Note 2
		θB		50	55	-		
		θL		55	60	-		
		θR		55	60	-		
Contrast Ratio		CR	θ=0°	200	400	-		Note1 Note3
Response Time		Ton	25℃	-	25	40	ms	Note1
		Toff						Note4
Chromaticity	White	x	Backlight is on	0.240	0.290	0.340		Note5, Note1
		y		0.260	0.310	0.360		
	RED	x		0.541	0.591	0.641		
		y		0.269	0.319	0.369		
	GREEN	x		0.281	0.331	0.381		
		y		0.535	0.585	0.635		
	BLUE	x		0.093	0.143	0.193		
		y		0.048	0.098	0.148		
Uniformity		U		75	80	-	%	Note1 Note6
NTSC				-	55	-	%	Note 5
Luminance		L		200	300	-	cd/m²	Note1 Note7

Test Conditions:

1. VCC=2.8V, $I_L=20mA$ (one LED current), the ambient temperature is 25°C.
2. The test systems refer to Note 1 and Note 2.

**Note 1: Definition of optical measurement system.**

The optical characteristics should be measured in dark room. After 5 minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.

**Note 2: Definition of viewing angle range and measurement system.**

viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).

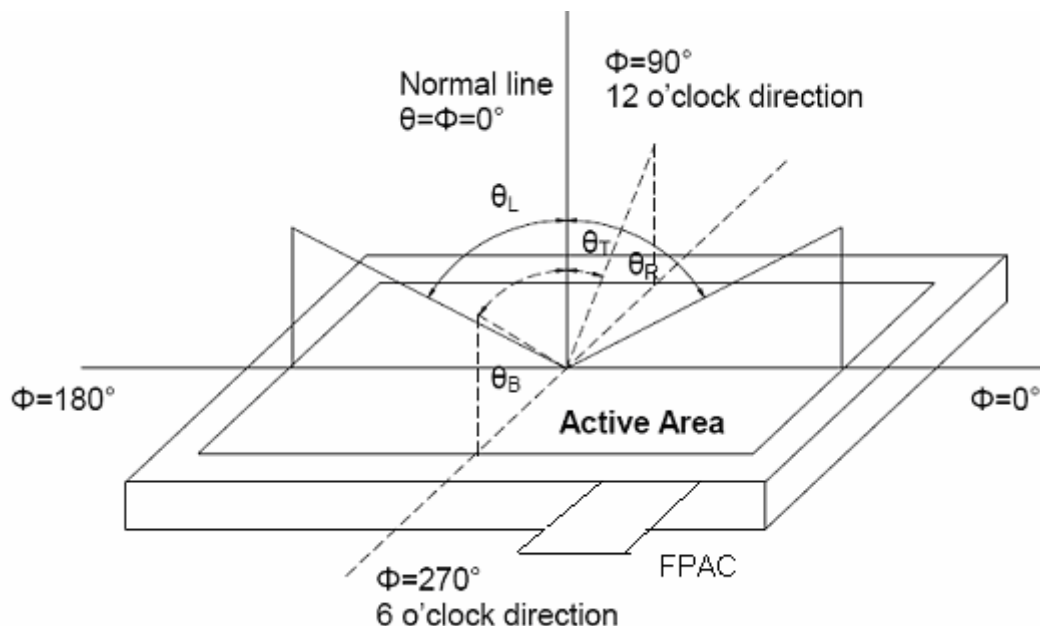


Fig. 1 Definition of viewing angle

**Note 3: Definition of contrast ratio**

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD is on the "White" state}}{\text{Luminance measured when LCD is on the "Black" state}}$$

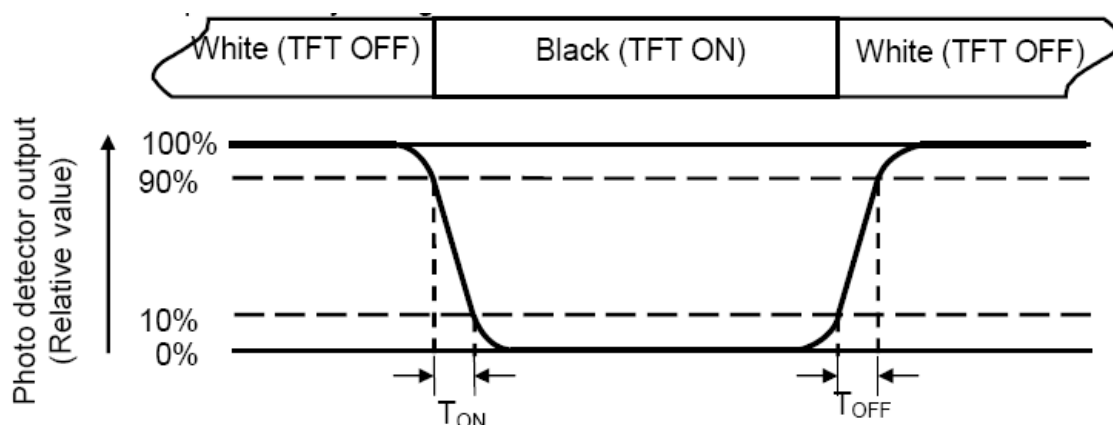
"White state": The state is that the LCD should driven by V_{white} .

"Black state": The state is that the LCD should driven by V_{black} .

V_{white} : To be determined V_{black} : To be determined.

Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%.

**Note 5: Definition of color chromaticity (CIE1931)**

Color coordinates measured at center point of LCD.

**Note 6: Definition of Luminance Uniformity**

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

$$\text{Luminance Uniformity}(U) = L_{\min} / L_{\max}$$

L-----Active area length W----- Active area width

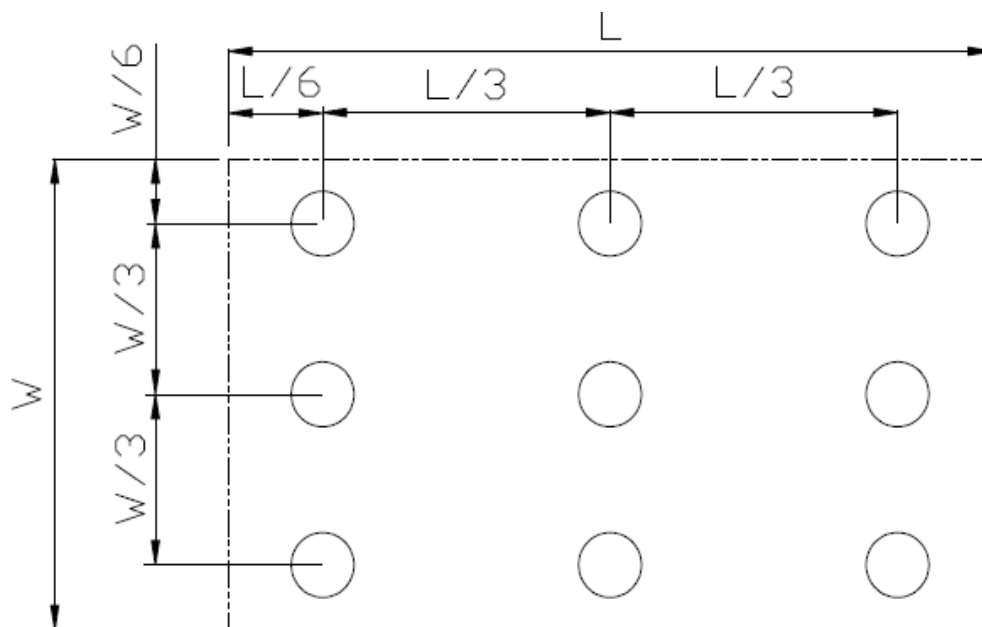


Fig. 2 Definition of uniformity

L_{\max} : The measured maximum luminance of all measurement position.

L_{\min} : The measured minimum luminance of all measurement position.

Note 7: Definition of Luminance :

Measure the luminance of white state at center point.



7 Environmental / Reliability tests

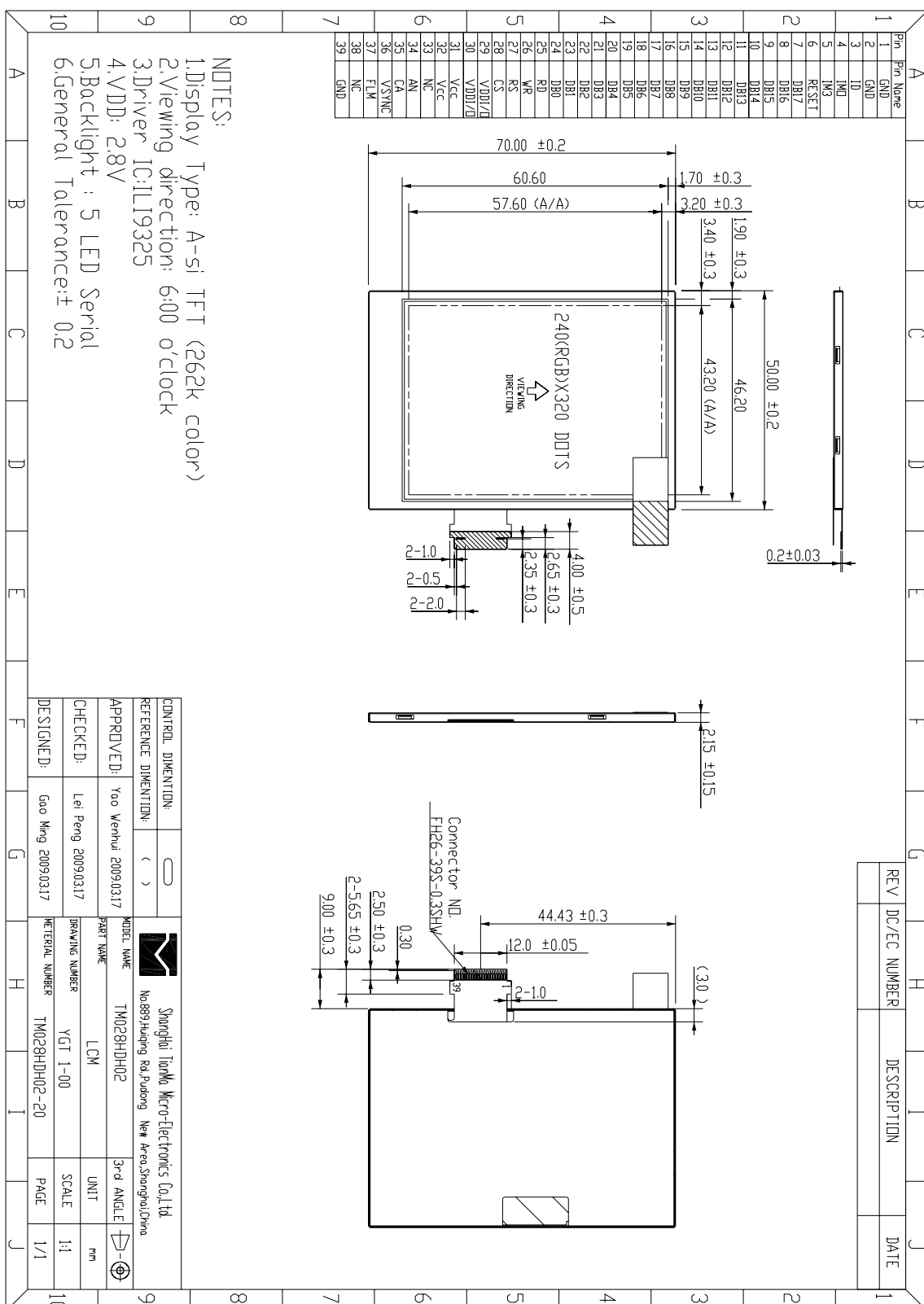
No	Test Item	Condition	Remarks
1	High Temperature Operation	Ts=+70℃, 240hrs	Note1 IEC60068-2-2,GB2423.2—89
2	Low Temperature Operation	Ta=-20℃, 240hrs	IEC60068-2-1 GB2423.1—89
3	High Temperature Storage	Ta=+80℃, 240hrs	IEC60068-2-2, GB2423.2—89
4	Low Temperature Storage	Ta=-30℃, 240hrs	IEC60068-2-1 GB2423.1—89
5	High Temperature & High Humidity Storage	Ta=+60℃, 90% RH 240 hours	Note2 IEC60068-2-3, GB/T2423.3—2006
6	Thermal Shock (Non-operation)	-30℃ 30 min~+80℃ 30 min, Change time:5min, 20 Cycles	Start with cold temperature, End with high temperature, IEC60068-2-14,GB2423.22—87
7	Electro Static Discharge (Operation)	C=150pF, R=330Ω, 5points/panel Air:± 15KV, 5times; Contact:± 8KV, 5 times; (Environment: 15℃~35℃, 30%~60%, 86Kpa~106Kpa)	IEC61000-4-2 GB/T17626.2—1998
8	Vibration (Non-operation)	Frequency range:10~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total)(Package condition)	IEC60068-2-6 GB/T2423.10—1995
9	Shock (Non-operation)	60G 6ms, ±X,± Y,± Z 3times, for each direction	IEC60068-2-27 GB/T2423.5—1995
10	Package Drop Test	Height:80 cm, 1 corner, 3 edges, 6 surfaces	IEC60068-2-32 GB/T2423.8—1995

Note1: Ts is the temperature of panel's surface.

Note2: Ta is the ambient temperature of sample.



8 Mechanical Drawing





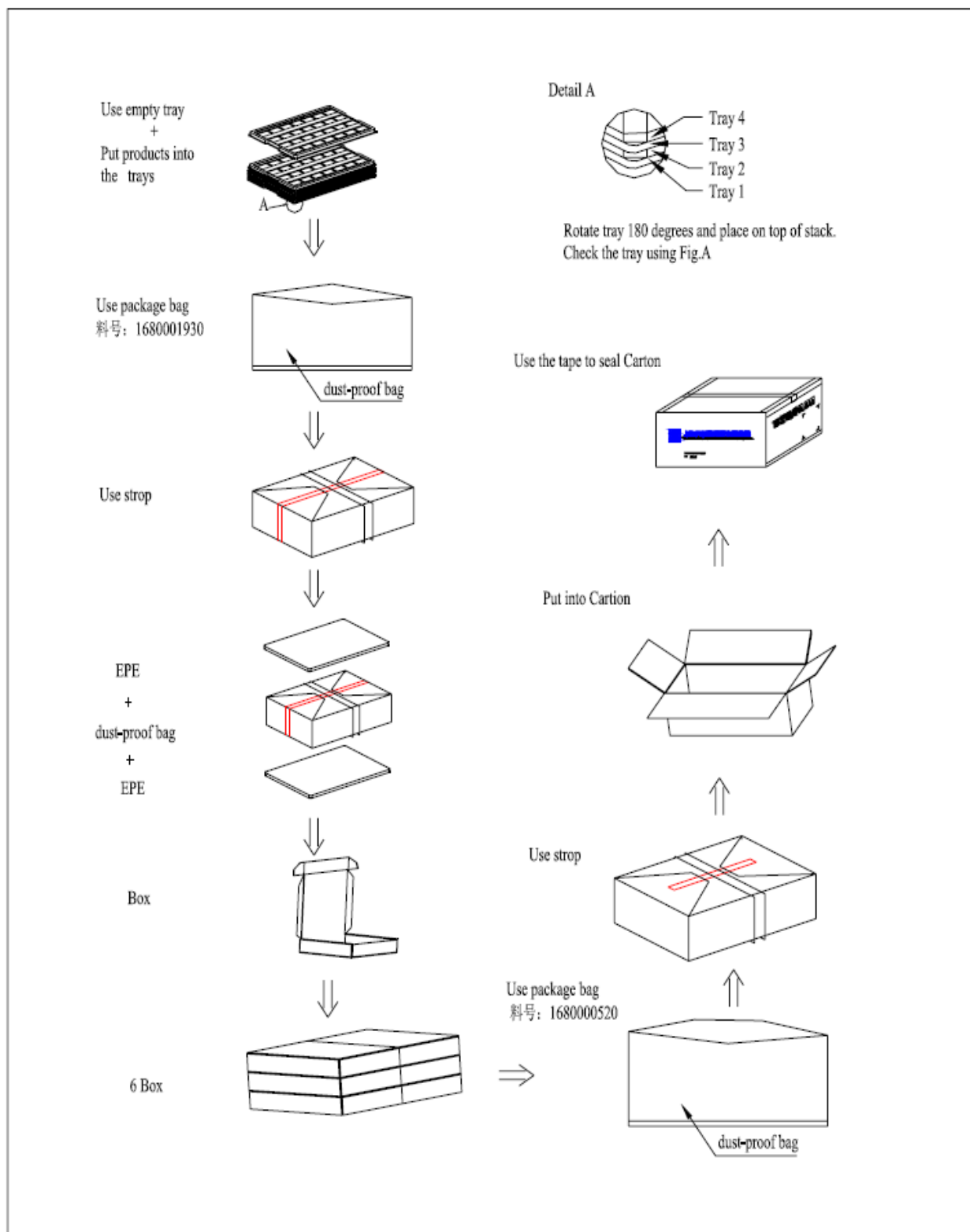
9 Packing Drawing

9.1 Packaging Material Table

No	Item	Model (Material)	Dimensions(mm)	Unit Weight(Kg)	Quantity	Remark
1	LCM module	TM028HDH02-20	50x70x2.15	0.0153	360	
2	Tray	PET(Transmit)	315x247x11.8	0.082	36	Anti-static
3	EPE	EPE	315x247x5	0.009	12	
4	DUST-PROOF Bag	PE	700x545	0.046	1	
5	Box	Corrugated Paper	345x260x70	0.227	6	
6	Carton	Corrugated Paper	544x365x250	1.01	1	
7	DUST-PROOF Bag	PE	440x327	0.021	6	
8	Total Weight(Kg)	11.112				



9.2 Packaging Drawing





10 Precautions for Use of LCD Modules

10.1 Handling Precautions

- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol、
 - Ethyl alcoholSolvents other than those mentioned above may damage the polarizer. Especially, do not use the following:
 - Water
 - Ketone
 - Aromatic solvents
- 10.1.6 Do not attempt to disassemble the LCD Module.
- 10.1.7 If the logic circuit power is off, do not apply the input signals.
- 10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - 10.1.8.1 Be sure to ground the body when handling the LCD Modules.
 - 10.1.8.2 Tools required for assembly, such as soldering irons, must be properly ground.
 - 10.1.8.3 To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - 10.1.8.4 The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

10.2 Storage precautions

- 10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:
Temperature : 0℃ ~ 40℃ Relatively humidity: ≤80%
- 10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.

10.3 Transportation Precautions:

The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.